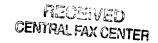
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE PATENT APPLICATION



MAR 1 4 2005

Appl. No.

10/762,122

Confirmation No. 3955

Applicant

Donald C. Abbott et al.

Filed

January 20, 2004

TC/A.U.

2812

Examiner

Roman, Angel

Docket No. : Customer No. :

TI-33737A 23494

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

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Amendment-A under 37 C.F.R. 1.111

Dear Sir:

Responsive to the Office action dated December 13, 2004, applicants amend the application as follows:

Listing of claims begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.

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MAR 1 4 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Abbott et al.

Docket Number: TI-33737A

Serial No.: 10/762,122

Art Unit: 2812

Filed: January 20, 2004

Examiner: Roman, Angel

For: **SEMIC**

SEMICONDUCTOR LEADFRAMES PLATED WITH THICK NICKEL,

MINIMUM PALLADIUM, AND PURE TIN

CERTIFICATION OF FACSIMILE TRANSMISSION

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|--|-------------------------------|--|
| Abbott et al. Title OF INVENTION: Semiconductor Leadframes Plated with.,. | | RECEIPT DATE & SERIAL NO.: Serial No.: 10/762,122 Filing Date: 01/20/2004 |
| TI-33737A | DEPOSIT ACCT. NO.: 20-0668 | |
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